

Meeting Minutes SCC18 Adhoc
July 25, 2018
1PM ET

13:05 Meeting called to order.

Adhoc Chair reviewed agenda slides, covered the IEEE patent policy and participation rules.

13:07 Meeting moved to main agenda. The group reviewed http://www.ieee802.org/3/ad_hoc/SCC_18/public/TC716_and_NEC_SR_comments-071818.pdf. Notes were taken in the reviewed document and a 072518 version will be posted.

Other relevant upcoming date/meetings:

NFPA Public Comment Deadline: Aug 30, 2018

PT716 comment due date: Sept 14, 2018

2020 NEC Second Draft Meeting October 22-November 3, 2018 San Diego, CA

The next scheduled SCC18 adhoc meeting is August 1, 2018, 1PM ET.

13:32: Having exhausted agenda and lost quorum, the meeting was adjourned.

Attendance:

Name	Employer; Affiliation	Present
Chad Jones	Cisco; Cisco	*
David Tremblay	HPE; HPE	*
Geoff Thompson	Unemployed; Unaffiliated	*
George Zimmerman	CME; APL, BMW, Cisco, Commscope, LTC/ADI	*
Andrew Jimenez	Anixter; Anixter	
Arkadiy Peker	Microsemi; Microsemi	
Bill Szeto	Retired; Unaffiliated	
Borhan Fathi	Nvidia; Nvidia	
Chris DiMinico	MC Communications; Panduit	
Craig Chabot	UNH-IOL; UNH-IOL	
Curtis Donahue	UNH-IOL; UNH-IOL	
David Law	HPE; HPE	
Ernie Gallo	Ericsson; Ericsson	
Fred Dawson	Chemours; Chemours	
James Withey	Fluke; Fluke	
Jeff Lapak	UNH-IOL; UNH-IOL	
Jennifer Santalli	STAFF	
Jim Brunssen	Ericsson; Ericsson	
Joel Goergen	Cisco; Cisco	
John Fuller	AT&T; AT&T	
Jonathan Goldberg	STAFF	
Ken Bennett	Sifos; Sifos	

Masood Shariff	Commscope; Commscope	
Matthew Ceglia	STAFF	
Mike Anthony	StandardsMichigan, LLC, StandardsMichigan, LLC	
Miklos Lucas	Silicon Labs; Silicon Labs	
Pat Roder	STAFF	
Paul Nikolich	Independent	
Paul Vanderlaan	Berk-Tek LLC; Berk-Tek LLC	
Rick Voss	Panduit; Panduit	
Ron Tellas	Belden, Belden	
Sesha Panguluri	Broadcom; Broadcom	
Shiyong Fu	Huawei; Huawei	
Steve Carlson	High Speed Design, Inc.; High Speed Design, Inc.	
Valerie Maquire	Siemon; Siemon	
Yair Darshan	Microsemi; Microsemi	